| http:// supplier Information company name* nsemi contact Name | Veb Site for Information on I/www.ipc.org/IPC-175x | Company un                   |                                | Form Type * Distribute    | Clas  |                         | o, Homogeneous Materia | als and Mfg Informat                             | ion                             |           |  |  |
|---|--|------------------------------|--------------------------------|---------------------------|---|-------------------------|------------------------|--|---------------------------------|-----------|--|--|
| ompany name* nsemi ontact Name                                |  |                              | ique ID                        |                           | Unique ID Auth                              |                         |                        |  |                                 |           |  |  |
| nsemi<br>Contact Name   |  |                              | ique ID                        |                           | Unique ID Auth                              |                         |                        |  |                                 |           |  |  |
| ontact Name   |  | m                            |                                |                           | Ollique ID Autil                            | Unique ID Authority     |                        |  | Response Date*                  |           |  |  |
|   |  | m: 1 G                       |                                |                           |   |                         |                        | 2024-05-18                                       |                                 |           |  |  |
| Product_Env_Stowards  |  | Contact Name Title - Contact |                                |                           | Phone - Contac                              | act* Emai               |                        | Email - Contact*                                 | nail - Contact*                 |           |  |  |
| Toutet-Env-Stewarus   | Product-Env-Stewards Produ                         |                              |                                | Product Enviro Compliance |   | NA                      |                        |  | Product-Env-Stewards@onsemi.com |           |  |  |
| Authorized Representative* Title - Repre                      |  |                              | epresentative                  |                           | Phone - Repres                              | Phone - Representative* |                        |  | Email - Representative*         |           |  |  |
| Product-Env-Stewards  | Product Enviro Compliance                          |                              |                                | NA                        | NA  |                         |                        | Product-Env-Stewards@onsemi.com                  |                                 |           |  |  |
| Requester Item Nu   | Tumber Mfr Iten                                    | Number                       | Mfr Item Name                  |                           | Effective Date                              | Version                 | Manufacturing Site     | Weight*  | UOM                             | Unit Type |  |  |
|   | FDWS9:   |                              | 09L-F085 PMOS PWR56 40V 8 MOHM |                           | 2024-05-18 PBB                              |                         | PBB                    | 161.1927   | mg                              | Each      |  |  |
| Janufacturing Process   |  | Corminal Daga                | Alloy                          | TD-020 MSL Rating         | Paul Progr                                  | os Pady Tamparat        | ure Max Time at Peak   | Tamparatura Numb                                 | or of Poflow Cv                 | olos      |  |  |
| 2 7   |  | CU Alloy J-STD-020 MSL Ra    |                                | 1D-020 MSL Railing        | Peak Process Body Temperature Max Time at F |                         |                        | ak Temperature Number of Reflow Cycles seconds 3 |                                 |           |  |  |
| •   | anneareu   | O Alloy                      | 1                              |                           | 200   |                         | 30                     | seconds 3  |                                 |           |  |  |
| omments vel 1 - maximum time at pe                            | aak tampanatuna during sa                          | Idoring is 10-2              | 10 seconds                     |                           |   |                         |                        |  |                                 |           |  |  |
| vei 1 - maximum time at pe<br>or more information regard      |  |                              |                                |                           |   |                         |                        |  |                                 |           |  |  |

| RoHS Material Composition Declaration  |   |  | Declaration Type *   | Detailed   |  |  |  |  |  |
|--|---|--|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominal contains a RoHS restricted substance inexcess encompass all such components. Supplier certi as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided by certification in this paragraph. If the Company | ted biphenyls and/or polybrominated dipheny<br>of an applicable quantity limit, please indicate<br>fies that it gathered the information it provident.<br>Supplier acknowledges that Company will<br>we relied on information provided by others in<br>the supplier agrees that, at a minimum<br>and the Supplier enter into a written agreements<br>ource of the Supplier's liability and the Com-                               | 2011/65/EU and implemented by the laws of the End ethers (each a "RoHS restricted substance") in except the below which, if any, RoHS exemption you believe in this form using appropriate methods to ensure rely on this certification in determining the compliant completing this form, and that Supplier may not have its suppliers have provided certifications regarding ent with respect to the identified part, the terms and capany's remedies for issues that arise regarding information in the content of the content with the supplier of the identified part, the terms and capany's remedies for issues that arise regarding information in the content of t | sess of the applicable quantity limit identified able may apply. If the part is an assembly with low its accuracy and that such information is true annee of its products with European Union member ave independently verified such information. However, their contributions to the part, and those certifications of that agreement, including any warr | bove. If a homogeneous material within the part ver level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. It is involved in situations where Supplier has not ations are at least as comprehensive as the ranty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 4 - Item(s  | ) does not contain RoHS restricted substance  | s per the definition above except for selected exemp   | tions Supplier Acceptance  | * Accepted   |  |  |  |  |  |
| Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).  |   |  |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |  |  |  |  |  |  |  |
| Declaration Signature  |   |  |  |  |  |  |  |  |  |
| Instructions: Complete all of the required f<br>Requester) and click on Submit Form to ha  |   | Accepted" on the Supplier Acceptance drop-dow  | n. This will display the signature area. Digita  | lly sign the declaration (if required by the   |  |  |  |  |  |
| Supplier Digital Signature Ra  | astislav Drska  | -En  |  |  |  |  |  |  |  |

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance           | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|---------------------|------------------|--------|---------|-----------------|
| Die                  | 4.8845 | mg              | Supplier | Silicon (Si)        | 7440-21-3        |        | 4.8845  | mg              |
| Die Attach Solder    | 4.5182 | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.113   | mg              |
|                      |        |                 | A        | Lead (Pb)           | 7439-92-1        | 7a     | 4.1793  | mg              |
|                      |        |                 | Supplier | Tin (Sn)            | 7440-31-5        |        | 0.2259  | mg              |
| Lead Frame           | 55.839 | mg              | Supplier | Zinc (Zn)           | 7440-66-6        |        | 0.0223  | mg              |
|                      |        |                 | В        | Nickel (Ni)         | 7440-02-0        |        | 0.6701  | mg              |
|                      |        |                 | Supplier | Iron (Fe)           | 7439-89-6        |        | 1.4741  | mg              |
|                      |        |                 | Supplier | Copper (Cu)         | 7440-50-8        |        | 53.6669 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)      | 7723-14-0        |        | 0.0056  | mg              |
| Mold Compound-Black  | 72.7   | mg              |          | Proprietary         | proprietary data |        | 5.816   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)    | 1333-86-4        |        | 0.3635  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2) | 60676-86-0       |        | 66.5205 | mg              |
| Plating              | 16.979 | mg              | Supplier | Tin (Sn)            | 7440-31-5        |        | 16.979  | mg              |
| Wire Bond - Al       | 6.272  | mg              | В        | Nickel (Ni)         | 7440-02-0        |        | 0.0003  | mg              |
|                      |        |                 | Supplier | Aluminum (Al)       | 7429-90-5        |        | 6.2717  | mg              |